



Docket No.: H0498.70155US00
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hong Yang et al.
Serial No.: 09/940,072
Confirmation No.: 3068
Filed: August 27, 2001
For: FABRICATION OF CERAMIC MICROSTRUCTURES
Examiner: C. N. Lopez
Art Unit: 1731

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Dated: 11/24/07

Signature

AMENDMENT AFTER ALLOWANCE UNDER 37 C.F.R. 1.312

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Applicants respectfully request entry of this amendment under 37 C.F.R. §1.312.

The Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 11 of this paper.